

SSC8122GN1

N-Channel Enhancement Mode MOSFET with ESD protection

> Features

VDS	VGS	RDSON Typ.	ID	ESD
		195mR@4V5		
20V	±8V	240mR@2V5	1.1A	2K
		305mR@1V8		

> Description

This device is a N-Channel enhancement mode MOSFET which is produced with high cell density and DMOS trench technology. This device particularly suits low voltage applications, especially for battery powered circuits, the tiny and thin outline saves PCB consumption.

Applications

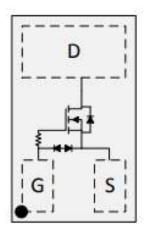
- Load Switch
- Portable Devices

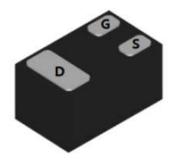
> Ordering Information

Device	Package	Shipping	
SSC8122GN1	DFN1006	10K/Reel	

Pin configuration

Top view





Bottom View



Marking



➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V_{DSS}	Drain-to-Source Voltage	20	V
V _{GSS}	Gate-to-Source Voltage	±8	V
ID	Continuous Drain Current ^a	1.1	Α
I _{DM}	Pulsed Drain Current ^b	3.1	Α
P_D	Power Dissipation ^c	0.32	W
P _{DSM}	Power Dissipation ^a	0.18	W
TJ	Operation junction temperature	-55 to 150	°C
T _{STG}	Storage temperature range	-55 to 150	°C

➤ Thermal Resistance Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a		690	°C/W
ReJC	Junction-to-Case Thermal Resistance		379	C/W

Note:

- a. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with T_A =25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t \leq 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

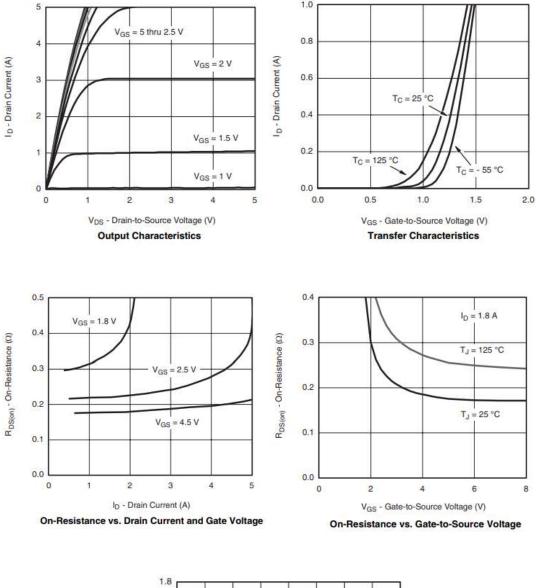


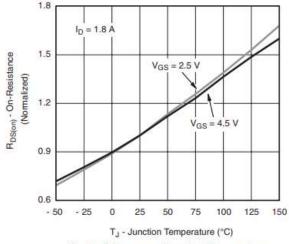
➤ **Electronics Characteristics**(T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V , ID=250uA	20			V
V _{GS} (th)	Gate Threshold Voltage	VDS=VGS , ID=250uA	0.5	0.68	1	V
	Davin Course On	VGS=4.5V , ID=0.5A		195	310	
R _{DS(on)}	Drain-Source On-	VGS=2.5V , ID=0.5A		240	380	mR
	Resistance	VGS=1.8V , ID=0.35A		305	800	
I _{DSS}	Zero Gate Voltage Drain Current	VDS=20V , VGS=0V			1	uA
I _{GSS}	Gate-Source leak	VGS=±8V , VDS=0V			±10	uA
G _{FS}	Transconductance	VDS=5V , ID=0.5A		2		S
V _{SD}	Forward Voltage	VGS=0V , IS=0.5A		0.7	1.3	V
Ciss	Input Capacitance			66	85	
Coss	Output Capacitance	VDS=10V , VGS=0V, f=1MHz		18		pF
Crss	Reverse Transfer Capacitance			9		
T _{D(ON)}	Turn-on delay time			20		
Tr	Rise time	VGS=4.5V ,		13		
T _{D(OFF)}	Turn-off delay time	VDS=10V, RG=6R,ID=0.6A		40		ns
Tf	Fall time			12		



➤ Typical Characteristics(T_A=25°C unless otherwise noted)



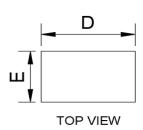


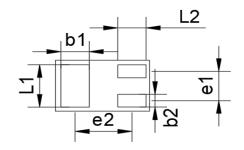
On-Resistance vs. Junction Temperature



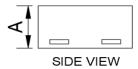
> Package Information

POD



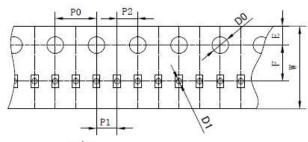


BOTTOM VIEW

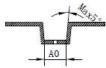


COMMON DIMENSION (MM)					
PKG		DFN1006			
REF.	MIN.	MIN. NDM, MAX			
Α	0.40	0.50	0,55		
D	0.90	1.00	1.05		
Е	0.50	0.60	0.65		
bl	0.20	0.25	0.30		
b2	0.10	0.15	0.20		
LI	0.45	0.50	0.55		
L2	0.25	0.30	0.35		
el		0.350 BSC			
e2	0.675 BSC				

Tape Data







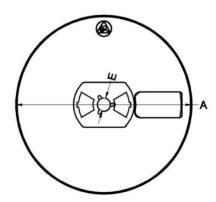
SYMBOL	AO	ВО	КО	P0	P1	P2
SPEC	0.69±0.05	1.15±0.05	0.60±0.05	4.00±0.10	2.00±0.05	2.00±0.05
SYMBOL	T	E	F	D0	D1	W
SPEC	0.18±0.03	1.75±0.10	3.50±0.05	1.55±0.05	0.50±0.05	8.00 +0.5

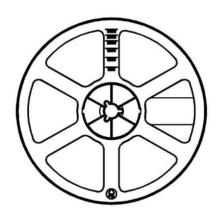
NOTE:

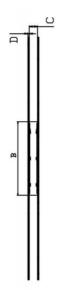
- 1. 材料: 黑色防静电材料;
- 2.10个链孔的累积公差不能超过±0.2
- 3. 尺寸符合EIA-481-E的要求。



Reel Data







MLLMETERS					
DCM	MIN	MAX			
A	178.00	179.00			
В	51.00	52.00			
C					
D	1. 10	1.50			
E	13. 20	13.70			

		С		
DCM	8轴心	12轴心	16轴心	
MIN	9. 2	12. 5	16.5	
MAX	10.2	13. 5	17.5	



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